

Security Level:

# Considerations on 200GE SMF wavelength choice for 10km

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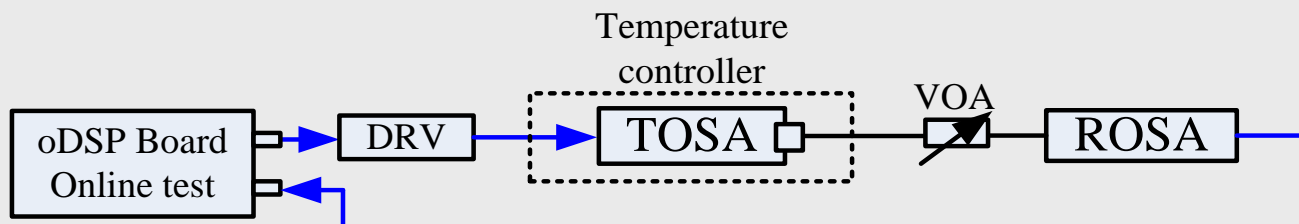
# Supporters

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Hideki Isono	Fujitsu Optical Components
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Kohichi Tamura	Oclaro
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Zhigang Gong	O-Net
Ed Ulrichs	Source Photonics
Hanan Leizerovich	Multiphy
Li Cao	Accelink

# Introduction

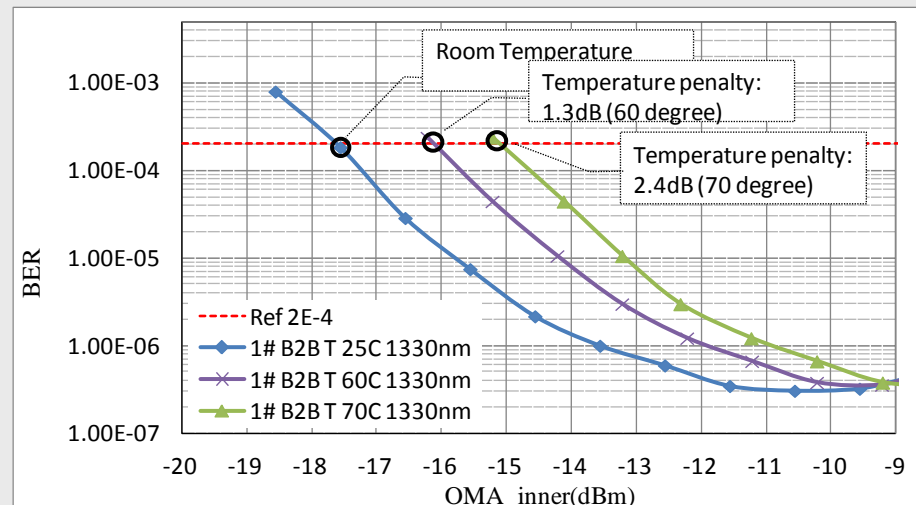
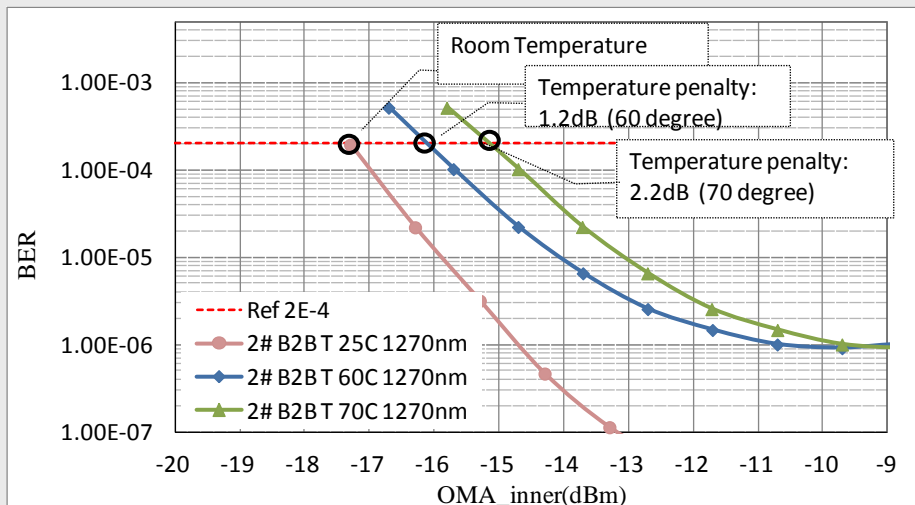
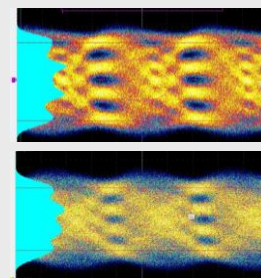
- **Objective**
  - Find an appropriate solution for 200GBASE-LR4 to enable near term deployment of 200 GbE with robust link performance over worst case 10km SMF.
- **Satisfactory Technical Performance and near term deployment are the priority for the choice of 200GbE 10km wavelength grid**
  - Laser chirp in combination with worst case dispersion over the specified wavelengths range must be considered for robust-interoperable operation of the 200GBASE-LR4 link.
- **In this presentation both a LAN-WDM (worst case 1310nm) and CWDM (worst case 1337.5nm) link penalties are investigated.**

# Temperature Performance of Uncooled DML



Room temperature

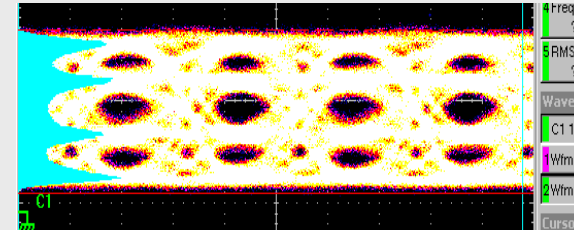
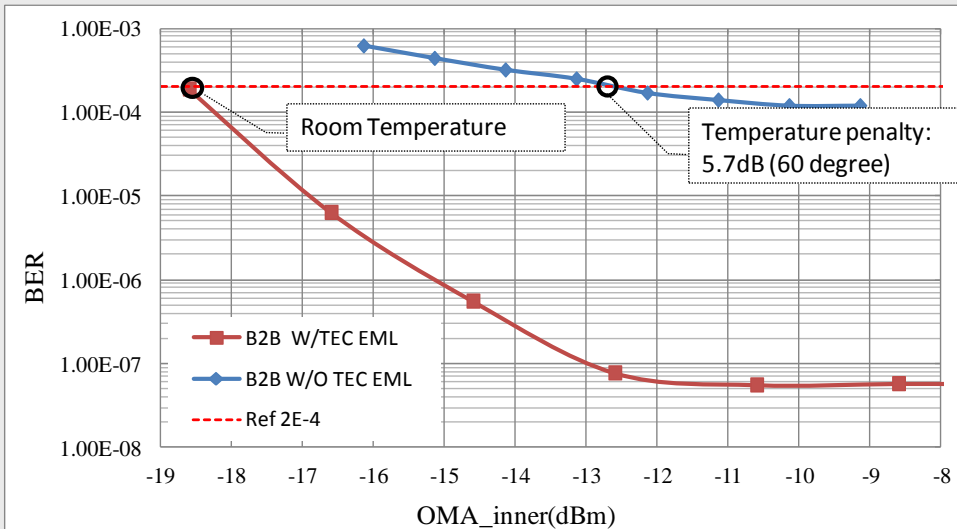
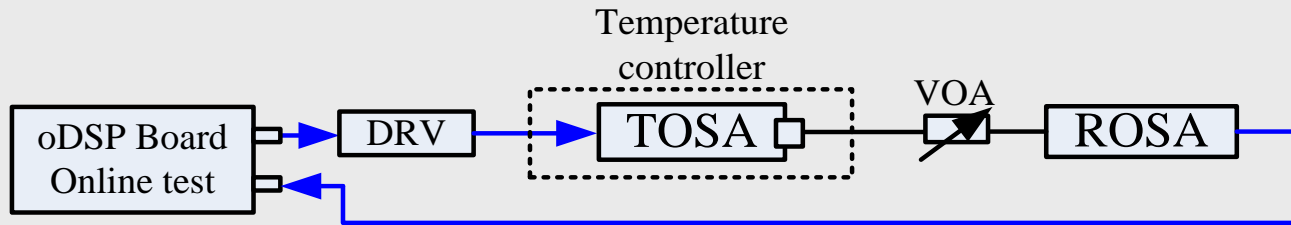
Temperature  
60 degree



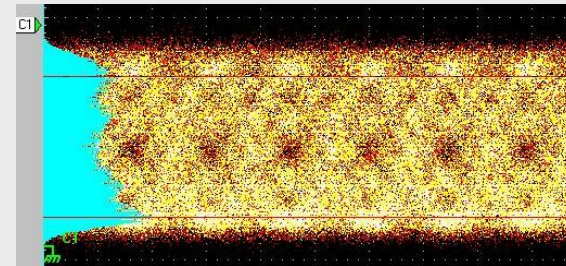
	Temperature penalty @25C [dB]	Temperature penalty @60C [dB]	Temperature penalty @70C [dB]
DML1 no TEC	0	1.2	2.2
DML2 no TEC	0	1.3	2.4

- ◆ The alpha parameter used in this test is 1.7
- ◆ Tested DMLs are from commercial DML suppliers
- ◆ High temperature performance degradation of the uncooled DML introduces unacceptable amount of penalty!

# High Temperature Performance (Uncooled EML)



Room temperature



Temperature 60 degree

	Temperature penalty @25C [dB]	Temperature penalty @60C [dB]
EML1 no TEC	0	5.7

- ◆ Tested EML is from commercial EML suppliers
- ◆ High temperature performance degradation of the uncooled EML introduces unacceptable amount of penalty!

# Alpha-factor in DFB laser and dispersion in CWDM

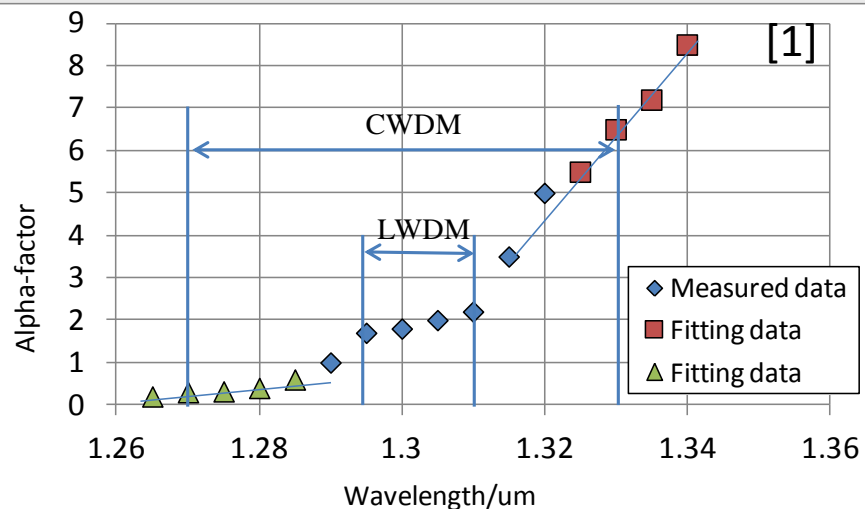
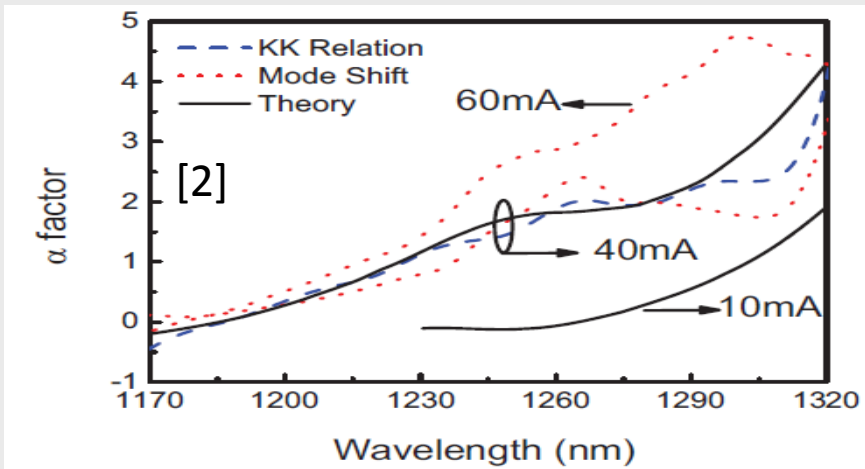
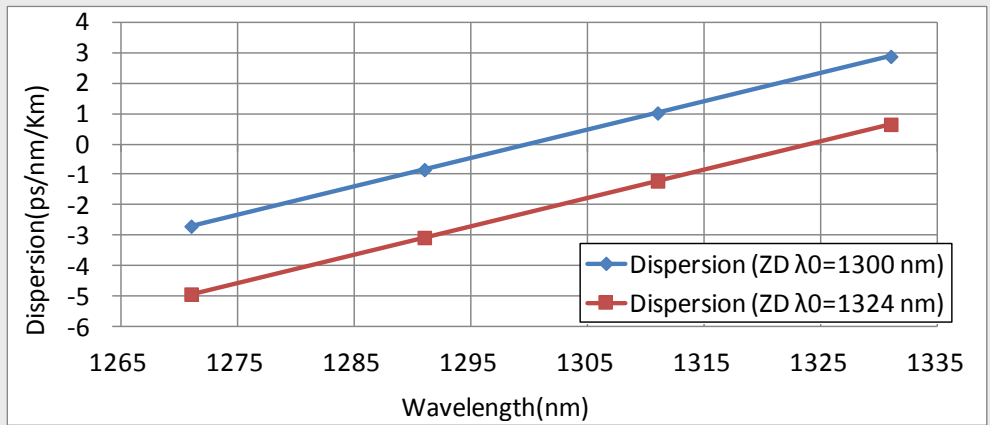


Table 122-13—Optical fiber and cable characteristics

Description	Value	Unit
Nominal fiber specification wavelength	1310	nm
Cabled optical fiber attenuation (max)	0.5 <sup>a</sup>	dB/km
Zero dispersion wavelength ( $\lambda_0$ )	$1300 \leq \lambda_0 \leq 1324$	nm
Dispersion slope (max) ( $S_0$ )	0.093	ps/nm <sup>2</sup> km



[1] IEEE Photonics Technology Letters, Vol.3 No.10,1991  
 [2] IEEE Photonics Technology Letters, Vol.25,No.5,2013

**The Worst Case Situation in CWDM configuration**

- 1. Fiber: ZDW:1300nm, 10km dispersion: 33.4 ps/nm @1337.5nm (Corner wavelength)**
- 2. DML alpha-factor: >4.5 (@1337.5nm)**

# Dispersion penalty

Online Test, Tx: DML, Rx EQ: **7-tap T/2 spaced FFE**

Test Wavelength	Dispersion Parameter of fiber	Transmission length	Total dispersion	Alpha parameter	Dispersion Penalty
1311 nm	1.02 ps/nm*km	33km	33.66 ps/nm	3.4	2.2dB
1330 nm	2.88 ps/nm*km	12 km	34.56 ps/nm	4.7	3.5dB

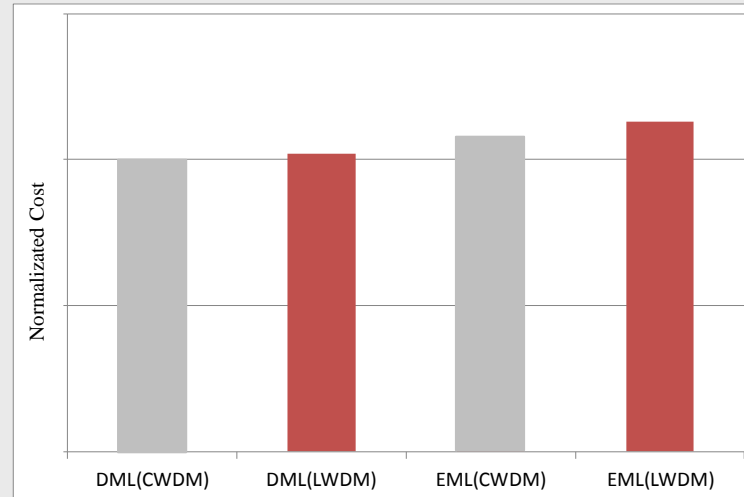
Commercial simulation model, **7-tap T/2 spaced FFE**

Alpha-factor	Dispersion Penalty in dB @ CWDM corner wavelength 1337.5nm @10Km	Dispersion Penalty in dB @ LAN- WDM corner wavelength 1310.19nm @10Km
<b>3.5</b>	2.1	0.3
<b>4.5</b>	3.2	0.4

- ◆ A transmitter with 1337.5nm wavelength is not available. Instead a transmitter with lower wavelength @1330nm was used to test under 34ps/nm worst case dispersion conditions
- ◆ Both offline test and simulation show the penalty for high dispersion with high alpha factor



# Cost analysis



- ◆ Main cost of module is from COC chip
- ◆ The main cost difference between CWDM and LAN-WDM caused by TEC and optical Mux/De-Mux
- ◆ The cost of TEC is a small part in the whole BOM
- ◆ The cost difference between an EML and a DML capable of 50G PAM4 is not substantial
- ◆ Availability of uncooled DFB-DML TOSA meeting performance requirement may jeopardize early deployment!

# Wavelength options for 200GBASE-LR4

	LAN-WDM	CWDM
Pros.	<ol style="list-style-type: none"><li>1. Technically mature and stable</li><li>2. High stability with temperature variation .</li><li>3. Much smaller Dispersion penalty than CWDM at corner wavelength.</li><li>4. Reuse the components from 400GBASE-FR8 and 400GBASE-LR8</li></ol>	<ol style="list-style-type: none"><li>1. Could be uncooled</li><li>2. Technically feasible (but maybe not sufficiently robust)</li></ol>
Cons.	<ol style="list-style-type: none"><li>1. TEC required</li></ol>	<ol style="list-style-type: none"><li>1. Performance degeneration under high temperature</li><li>2. Large dispersion penalty at highest wavelength</li><li>3. Require low chirp temp stable DFB-DML otherwise force using TEC</li><li>4. Yield and component availability</li></ol>

# Conclusions

- ◆ The cost difference between TOSA W/ TEC and W/O TEC is not significant
  - ◆ The LAN-WDM components are leveraged from 400GBase-FR8/LR8
- ◆ A (un)cooled DML transmitters may have insufficient and/or low yield for reliable link operation over worst case 10km SMF due to high dispersion penalty coupled with device alpha parameter
- ◆ Relying on (un)cooled DFB-DML transmitter may jeopardize near term deployment of 200GBASE-LR4
- ◆ We propose to use LAN-WDM wavelength grid for 200GBASE-LR4 to mitigate any risk and avoid any schedule impact to the IEEE P802.3bs.

# Baseline Proposal for 10km

	Description	200GBASE-LR4 (LWDM)
Tx	Reach/Km	<b>10</b>
	Signaling Rate/Gbaud	<b>26.56</b>
	Operating BER	<b>2.00E-04</b>
	OMA11-00,each lane(min)/dBm	<b>0.2</b>
	TDP each lane/dB	<b>2.4</b>
	OMA11-00-TDP, each lane(min)/dBm	<b>-0.8</b>
	Extinction Ratio (min)/dB	<b>4.5</b>
Link	Channel loss/dB	<b>6.3</b>
	MPI/dB	<b>0.5</b>
Rx	Signaling Rate,each lane/Gbaud	<b>26.56</b>
	Operating BER	<b>2.00E-04</b>
	Rx Sensitivity (OMA <sub>11-00</sub> )	<b>-7.60</b>
	Rx Sensitivity (OMA <sub>01-00</sub> )	<b>-12.4</b>

**Refer to stassar\_3bs\_01\_0516**

# Baseline Proposal for 2km

	Description	200GBASE-FR4 ( CWDM )	200GBASE-FR4 ( LWDM )
Tx	Reach/Km	2	2
	Signaling Rate/Gbaud	26.56	26.56
	Operating BER	2.00E-04	2.00E-04
	OMA11-00,each lane(min)/dBm	-0.5	-0.5
	TDP each lane/dB	2.4	2.2
	OMA11-00-TDP, each lane(min)/dBm	-1.5	-1.5
	Extinction Ratio (min)/dB	4.5	4.5
Link	Channel loss/dB	4	4
	MPI/dB	0.3	0.3
Rx	Signaling Rate,each lane/Gbaud	26.56	26.56
	Operating BER	2.00E-04	2.00E-04
	Rx Sensitivity (OMA <sub>11-00</sub> )	-5.80	-5.80
	Rx Sensitivity (OMA <sub>01-00</sub> )	-10.6	-10.6

**Refer to stassar\_3bs\_01\_0516**

## Back-up slide

# Chirp in DFB laser and dispersion in optical fiber

## Laser Rate Equation Model

$$\frac{dn}{dt} = \frac{i(t)}{qV_a} - r[n(t)] - g_m[n(t), p(t)] \cdot p(t)$$

$$\frac{dp}{dt} = \left[ \Gamma g_m[n(t), p(t)] - \frac{1}{\tau_{ph}} \right] \cdot p(t) + r_{sp}[n(t)]$$

$$\Delta\omega(t) = \frac{d\phi}{dt} = \frac{1}{2} \alpha \left[ \Gamma g_m[n(t), 0] - g_m(N_{th}, 0) \right]$$

$$g_m(n, p) = G_0 \ln\left(\frac{n}{N_0}\right) \cdot \frac{1}{1 + \epsilon p}$$

$$r(n) = \frac{n}{\tau_s} + Bn^2 + Cn^3$$

$$r_{sp}(n) = \beta_{sp} Bn^2$$

The alpha-factor affects the chirp, linewidth and line shape

Dispersion: it represents a broad class of phenomena related to the fact that the velocity of the electromagnetic wave depends on the wavelength

### Worst Cases:

1. Positive chirp and Positive fiber dispersion.
2. Negative chirp and Negative fiber dispersion.

## Linear Fiber Propagation Model

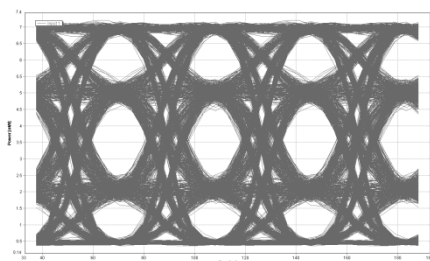
$$e(t, 0) = \sqrt{p(t)} e^{i\phi(t)}$$

$$\tilde{E}(\omega, 0) = \int_{-\infty}^{+\infty} e(t, 0) e^{-i\omega t} dt$$

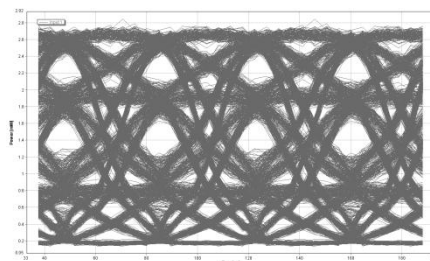
$$\tilde{E}(\omega, L) = \tilde{E}(\omega, 0) e^{+i\beta_2 \omega^2}$$

$$e(t, L) = \frac{1}{2\pi} \int_{-\infty}^{+\infty} \tilde{E}(\omega, L) e^{+i\omega t} d\omega$$

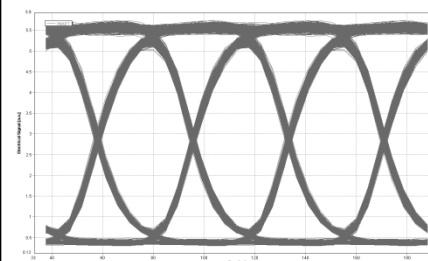
$$\beta_2 = \frac{\lambda^2}{4\pi c} DL$$



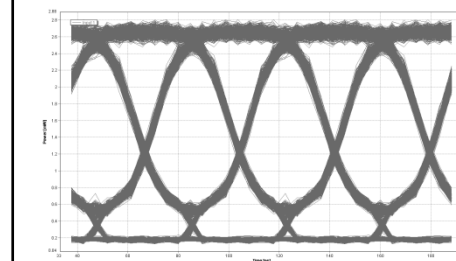
0Km, 1337.5nm DML  
Simulated result



10Km, 1337.5nm DML  
Simulated result



0Km, 1337.5nm DML  
Simulated result



10Km, 1337.5nm DML  
Simulated result

**Thank You**